

TinyLogic ULP-A Dual Inverter with Schmitt-Trigger Input

NC7WP14

The NC7WP14 is a dual inverter with Schmitt-trigger input in tiny footprint packages. The device is designed to operate for $V_{CC} = 0.9 \text{ V}$ to 3.6 V.

Features

- Designed for 0.9 V to 3.6 V V_{CC} Operation
- 3.0 ns t_{PD} at 3.3 V (Typ)
- Inputs/Outputs Over-Voltage Tolerant up to 3.6 V
- I_{OFF} Supports Partial Power Down Protection
- Source/Sink 2.6 mA at 3.3 V
- Available in SC−88 and MicroPak[™] Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

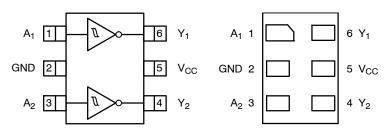


Figure 1. SC-88 (Top View)

Figure 2. MicroPak (Top Through View)

1

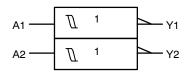


Figure 3. Logic Symbol

PIN ASSIGNMENT

Pin	Function
1	A1
2	GND
3	A2
4	Y2
5	V _{CC}
6	Y1

MARKING DIAGRAMS



SIP6 1.45X1.0 **MicroPak** CASE 127EB



CC = Specific Device Code

KK = 2-Digit Lot Run Traceability Code

XΥ = 2-Digit Date Code = Assembly Plant Code



SC-88 **DF SUFFIX** CASE 419B-02



XXX = Specific Device Code

= Date Code

= Pb-Free Package

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 6 of this data sheet.

FUNCTION TABLE $(Y = \overline{A})$

Input	Output
Α	Υ
L	Н
Н	L

H = HIGH Logic Level L = LOW Logic Level

MAXIMUM RATINGS

Symbol	Cha	racteristics	Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +4.3	V
V _{IN}	DC Input Voltage		-0.5 to +4.3	V
V _{OUT}	DC Output Voltage	Active-Mode (High or Low State) Tri-State Mode (Note 1) Power-Down Mode (V _{CC} = 0 V)	-0.5 to V_{CC} + 0.5 -0.5 to +4.3 -0.5 to +4.3	V
I _{IK}	DC Input Diode Current	V _{IN} < GND	-50	mA
I _{OK}	DC Output Diode Current	V _{OUT} < GND	-50	mA
l _{OUT}	DC Output Source/Sink Current		±50	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin o	r Ground Pin	±50	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
TL	Lead Temperature, 1 mm from Case	for 10 Seconds	260	°C
TJ	Junction Temperature Under Bias		+150	°C
$\theta_{\sf JA}$	Thermal Resistance (Note 2)	SC-88 MicroPak	377 154	°C/W
P _D	Power Dissipation in Still Air	SC-88 MicroPak	332 812	mW
MSL	Moisture Sensitivity		Level 1	_
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V _{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 1000	V
I _{Latchup}	Latchup Performance (Note 4)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- Applicable to devices with outputs that may be tri-stated.
 Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.
- 4. Tested to EIA/JESD78 Class II.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit	
V_{CC}	Positive DC Supply Voltage		0.9	3.6	V
V _{IN}	DC Input Voltage		0	3.6	V
V _{OUT}	DC Output Voltage Active-Mode (High of Tri-State Mode) Power-Down Mode	lode (Note 1)	0 0 0	V _{CC} 3.6 3.6	
T _A	Operating Temperature Range		-40	+85	°C
t _r , t _f	Input Transition Rise and Fall Time		0	No Limit	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

				Т	A = 25°	С	T _A = -40°C to +85°C		
Symbol	Parameter	Condition	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit
V _P	Positive		0.9	-	0.62	-	-	-	V
	Threshold Voltage		1.1	-	-	1.0	-	1.0	
			1.4	-	-	1.2	-	1.2	
			1.65	-	-	1.5	_	1.5	
			2.3	-	-	1.9	_	1.9	
			3.0	-	-	2.6	-	2.6	
V_N	Negative		0.9	-	0.34	-	-	-	V
	Threshold Voltage		1.1	0.15	-	-	0.15	-	
			1.4	0.2	-	-	0.2	-	
			1.65	0.25	-	-	0.25	-	
			2.3	0.4	-	-	0.4	-	
			3.0	0.6	-	-	0.6	-	
V_{H}	Hysteresis		0.9	-	0.29	-	-	-	V
	Voltage		1.1	0.08	-	0.6	0.08	0.6	
			1.4	0.09	-	0.8	0.09	0.8	
			1.65	0.1	-	1.0	0.1	1.0	
			2.3	0.25	-	1.1	0.25	1.1	
			3.0	0.6	-	1.8	0.6	1.8	
V _{OH}	High-Level Output	$V_{IN} = V_{IH}$ or V_{IL}							V
	Voltage	I _{OH} = -20 μA	0.9	-	V _{CC} - 0.1	-	-	-	
			1.1 to 1.3	V _{CC} – 0.1	-	-	V _{CC} - 0.1	-	
			1.4 to 1.6	V _{CC} - 0.1	-	-	V _{CC} - 0.1	-	
			1.65 to 1.95	V _{CC} - 0.1	-	-	V _{CC} - 0.1	-	
			2.3 to 2.7	V _{CC} - 0.1	-	-	V _{CC} - 0.1	ı	
			3.0 to 3.6	V _{CC} – 0.1	-	-	V _{CC} - 0.1	-	
		$I_{OH} = -0.5 \text{ mA}$	1.1 to 1.3	0.75 x V _{CC}	-	-	0.70 x V _{CC}	-	
		I _{OH} = -1 mA	1.4 to 1.6	1.07	-	-	0.99	-	
		$I_{OH} = -1.5 \text{ mA}$	1.65 to 1.95	1.24	-	-	1.22	-	
		I _{OH} = -2.1 mA	2.3 to 2.7	1.95	-	-	1.87	-	
		$I_{OH} = -2.6 \text{ mA}$	3.0 to 3.6	2.61	-	-	2.55	-	
V _{OL}	Low-Level Output	$V_{IN} = V_{IH}$ or V_{IL}							V
	Voltage	I _{OL} = 20 μA	0.9	-	0.1	-	-	ı	
			1.1 to 1.3	-	-	0.1	-	0.1	
			1.4 to 1.6	-	-	0.1	-	0.1	
			1.65 to 1.95	-	-	0.1	-	0.1	
			2.3 to 2.7	-	-	0.1	-	0.1	
			3.0 to 3.6	-	-	0.1	-	0.1	
		I _{OL} = 0.5 mA	1.1 to 1.3	-	-	0.3 x V _{CC}	-	0.3 x V _{CC}	
		I _{OL} = 1 mA	1.4 to 1.6	-	_	0.31	-	0.37	
		I _{OL} = 1.5 mA	1.65 to 1.95	-	-	0.31	_	0.35	
		I _{OL} = 2.1 mA	2.3 to 2.7	-	-	0.31	_	0.33	
		I _{OL} = 2.6 mA	3.0 to 3.6	-	-	0.31	_	0.33	

DC ELECTRICAL CHARACTERISTICS (continued)

				T _A = 25°C			T _A = -40°C to +85°C		
Symbol	Parameter	Condition	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit
I _{IN}	Input Leakage Current	V _{IN} = 0 V to 3.6 V	0.9 to 3.6	-	-	±0.1	-	±0.5	μΑ
I _{OFF}	Power Off Leakage Current	V _{IN} = 0 V to 3.6 V or V _{OUT} = 0 V to 3.6 V	0	-	-	0.5	-	0.5	μΑ
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	0.9 to 3.6	_	-	0.9	_	0.9	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

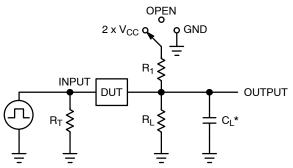
AC ELECTRICAL CHARACTERISTICS

				1	Γ _A = 25°()	T _A = -40°C	C to +85°C	
Symbol	Parameter	Condition	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit
t_{PLH} , t_{PHL}	Propagation Delay,	$R_L = 1 M\Omega$, $C_L = 10 pF$	0.9	-	51.2	-	-	-	ns
	A to Y (Figures 4 and 5)		1.10 to 1.30	-	14.0	28.6	-	37.3	
	,		1.40 to 1.60	_	7.5	15.8	-	16.0	
			1.65 to 1.95	-	5.4	12.0	-	12.2	
			2.3 to 2.7	-	3.7	9.4	-	9.9	
			3.0 to 3.6	-	3.0	8.3	-	9.0	
t _{PLH} , t _{PHL}	Propagation Delay,	$R_L = 1 M\Omega$, $C_L = 15 pF$	0.9	-	52.7	-	_	-	ns
	A to Y (Figures 4 and 5)		1.10 to 1.30	-	14.6	30.0	_	39.3	
	,		1.40 to 1.60	-	7.9	16.5	-	17.5	
			1.65 to 1.95	-	5.8	12.6	_	13.6	
			2.3 to 2.7	-	4.0	9.9	-	10.8	
			3.0 to 3.6	-	3.2	8.7	_	9.5	
t _{PLH} , t _{PHL}	Propagation Delay,	$R_L = 1 M\Omega$, $C_L = 30 pF$	0.9	-	56.9	-	-	-	ns
	A to Y (Figures 4 and 5)		1.10 to 1.30	-	16.2	34.0	_	48.3	
	,		1.40 to 1.60	-	9.3	18.8	_	19.2	
			1.65 to 1.95	-	6.9	14.4	-	15.9	
			2.3 to 2.7	-	4.7	11.3	_	12.8	
			3.0 to 3.6	-	3.8	9.2	-	10.7	

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Test Condition	Typical (T _A = 25°C)	Unit
C _{IN}	Input Capacitance	V _{CC} = 0 V	2.0	pF
C _{OUT}	Output Capacitance	V _{CC} = 0 V	4.0	pF
C _{PD}	Power Dissipation Capacitance (Note 5)	f = 10 MHz, V_{CC} = 0.9 to 3.6 V, V_{IN} = 0 V or V_{CC}	8.0	pF

^{5.} C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC}. C_{PD} is used to determine the no–load dynamic power consumption: P_D = C_{PD} • V_{CC}² • f_{in} + I_{CC} • V_{CC}.

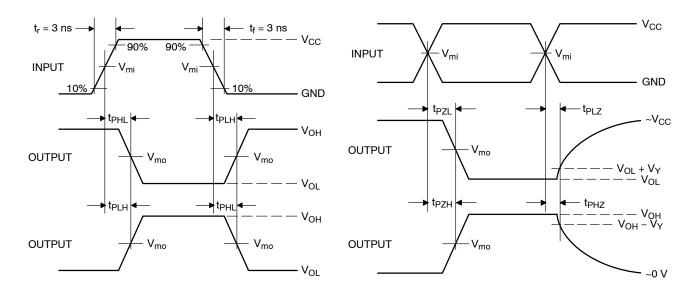


Test	Switch Position
t _{PLH} / t _{PHL}	Open
t _{PLZ} / t _{PZL}	2 x V _{CC}
t _{PHZ} / t _{PZH}	GND

C_L includes probe and jig capacitance

 R_T is Z_{OUT} of pulse generator (typically 50 Ω) f = 1 MHz

Figure 4. Test Circuit



V _{CC} , V	V _{mi} , V	V _{mo} , V	V _Y , V
0.9	V _{CC} / 2	V _{CC} / 2	0.1
1.1 to 1.3	V _{CC} /2	V _{CC} /2	0.1
1.4 to 1.6	V _{CC} / 2	V _{CC} /2	0.1
1.65 to 1.95	V _{CC} / 2	V _{CC} / 2	0.15
2.3 to 2.7	V _{CC} / 2	V _{CC} / 2	0.15
3.0 to 3.6	1.5	1.5	0.3

Figure 5. Switching Waveforms

ORDERING INFORMATION

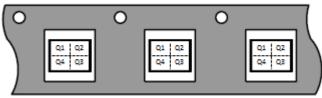
Device	Package	Marking	Pin 1 Orientation (See below)	Shipping [†]
NC7WP14P6X	SC-88	P14	Q4	3000 / Tape & Reel
NC7WP14L6X	MicroPak	AZ	Q4	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Pin 1 Orientation in Tape and Reel

Direction of Feed

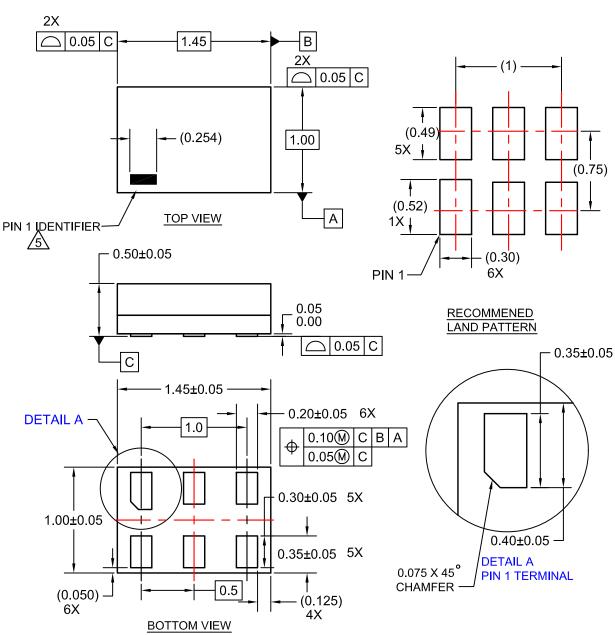




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PACKAGE DIMENSIONS

SIP6 1.45X1.0 CASE 127EB ISSUE O

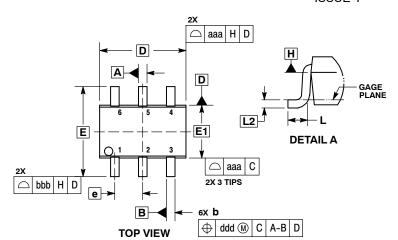


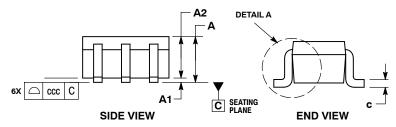
- NOTES:
- 1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-2009
- 4.PIN ONE IDENTIFIER IS 2X LENGTH OF ANY
 - OTHER LINE IN THE MARK CODE LAYOUT.

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363

CASE 419B-02 **ISSUE Y**





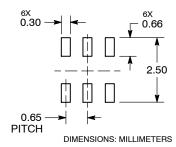
- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
 4. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.
 5. DATUMS A AND B ARE DETERMINED AT DATUM H.
 6. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
 7. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION

- DIMENSION 5 DOES NOT INCLUDE DAMBAR PROTRUSION.
 ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN
 EXCESS OF DIMENSION 5 AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER

	MIL	LIMETE	RS		INCHES	;
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α			1.10			0.043
A1	0.00		0.10	0.000		0.004
A2	0.70	0.90	1.00	0.027	0.035	0.039
b	0.15	0.20	0.25	0.006	0.008	0.010
С	0.08	0.15	0.22	0.003	0.006	0.009
D	1.80	2.00	2.20	0.070	0.078	0.086
E	2.00	2.10	2.20	0.078	0.082	0.086
E1	1.15	1.25	1.35	0.045	0.049	0.053
е		0.65 BS	С	0	.026 BS	С
L	0.26	0.36	0.46	0.010	0.014	0.018
L2	0.15 BSC			(0.006 BS	SC
aaa	0.15				0.006	
bbb	0.30				0.012	-
ccc	0.10			0.004		
ddd		0.10			0.004	

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting
Techniques Reference Manual, SOLDERRM/D.

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NLU2GU04BMX1TCG NLU2G04CMX1TCG NLV17SZ06DFT2G TC74VHC04FK(EL,K) NLV74HC04ADTR2G NLU1G04AMUTCG
NLX2G04CMUTCG NLX2G04AMUTCG NLU1GU04CMUTCG NLU1GT14AMUTCG NLU1G04CMUTCG NL17SZU04P5T5G
74LVC06ADTR2G 74LVC04ADR2G NLV37WZ04USG NLX3G14FMUTCG NL17SZ04P5T5G NLV17SG14DFT2G 74ACT14SC
BU4069UBF-E2 EMPP008Z NC7WZ14P6X NLV14106BDTR2G NLV74AC14DTR2G SN74HCT04DE4 ODE-3-120023-1F12
74VHCT04AM SV004IE5-1C TC74HC04APF TC7SH04F,LJ(CT TC7W14FK,LF 74VHC14MTCX 74LCX14MTC
SN74LVC1GU04DBVR NLU1G14BMX1TCG NLU2G04AMX1TCG NLU2G14AMX1TCG NLU3G14AMX1TCG NLVVHC1G04DFT2G
NLX2G04CMX1TCG NLX3G14AMX1TCG 74HC14T14-13